

4449.00 EUR  
incl. 19% VAT, plus [shipping](#)

- NVidia Orin Nano !
- 32GB RAM !
- IP66 !



- NVIDIA® Jetson AGX Orin™ SoM with 1792 CUDA Cores
- IP66 Design (Waterproof and Dustproof) for Harsh Environment
- 1 x 10 GbE, 2 GbE with PoE via Phoenix Contact® M12 IP67 Connectors
- 2 x CAN FD
- 2 x RS-232/422/485\*, 4 x DI/4 x DO\*
- Supporting 4 x GMSL-2 Cameras (via FAKRA Connectors)
- 9 ~ 60VDC Input with Built-in Smart Ignition Power Management
- -25 ~ 70°C Operating with Fanless Design
- Patented Design of Emergency Backup Battery (**Optional!**)
- **The “-LE” Model does not support GMSL-2 camera**

**System**

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**NVIDIA® Jetson AGX Orin™ 32GB – 200 TOPS**

**Module**

**(1792 CUDA® cores GPU + 8-core Arm Cortex-A78AE CPU + 32 GB LPDDR5)**

**Security**

**Security Boot, Arm TrustZone**

		- 1 x 10GbE, 2 x 2.5GbE w/ 2 x IEEE 802.3at PoE PSE Class 4 (PoE+ 30 watts) (3 x Phoenix Contact® M12 X-coded connectors)
		- 2 x USB Type-A/IP67 connector for USB 3.2 * One port share 10Gbps bandwidth
		- 1 x HDMI Type-A/IP67 connector for HDMI 2.1 output
<b>Interface</b>		- 1 x HD Audio from the HDMI
		- 1 x M12 A-coded connector for RS-232/422/485
		- 2 x M8 A-coded connectors for CAN FD
		- 1 x USB Type-C for System Recovery (Device only)
		- 4 x FAKRA-Z connectors for GMSL-2 cameras
		- 1 x Nano SIM card slot
		• 1 x M.2 3042/52 Key B slot (USB3.0) with a Nano SIM Card Slot
		• 1 x M.2 2230 Key E slot
<b>INTERNAL EXPANSION</b>		• * Thermal solution is required for M.2 5G Module
		• 1 x mPCIc Full size slot (USB.2.0 supported)
		• 1 x 64GB eMMC (Built-in within SoM)
<b>STORAGE (Internal)</b>		• 1 x M.2 2280 Key M slot supports NVMe SSD (Pre-installed)
<b>Operating System / SDK</b>		NVIDIA® JetPack including Jetson Linux, NVIDIA® development tools
		25°C ~ 70°C w/0.6 m/s airflow (for barebone system)
<b>Operating Temp.</b>		*Operating Temperature Varies by Accessories Installed.
		-40 ~ 85°C
<b>Storage Temp.</b>		
<b>Relative Humidity</b>		10% RH – 90% RH (non-condensing)
<b>Certification / Standard</b>		CE, FCC Class A, E-Mark, ECE R118, EN50155*, EN45545-2 (R25) *On going
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<b>Vibration</b>		• MIL-STD-810H, Method 514.6, Procedure I, Cat.4 (Operating)
		• IEC60068-2-64, random, 2.5G@5~500Hz, 1hr/axis
<b>Shock</b>		MIL-STD-810H, Method 516.6, Procedure I,
		Trucks and semi-trailers=15G (11ms) with SSD (Operating)
<b>Ingress Protection</b>		IP66
<b>Power Input</b>		• 1 x Phoenix Contact® M12 K-coded connector for DC-IN 9~60V Aluminum Alloy
		Fanless Passive Cooling Design
<b>Mechanical</b>		Wall Mount
		5100 g
		300 mm (L) x 190 mm (W) x 77,5 mm (H)